

Product Summary

B340AF/B345AF

Part Number	V _{RRM} (V)	I _O (A)	V _{F(MAX)} (V) @ +25°C	I _{R(MAX)} (mA) @ +25°C
B340AF	40	3	0.50	0.20
B345AF	45	3	0.50	0.30

Description and Applications

The B340AF is a 3A 40V and B345AF is a 3A 45V single rectifier packaged in the low profile SMAF package. Providing low V_F and excellent reverse leakage stability at high temperatures, this device is ideal for use in general rectification applications such as:

- Boost Diodes
- Blocking Diodes
- Recirculating Diodes

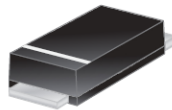
Features and Benefits

- Reduced Low Forward Voltage Drop (V_F); Better Efficiency and Cooler Operation
- Reduced High-temperature Reverse Leakage; Increased Reliability against Thermal Runaway Failure in High Temperature Operation.
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

Mechanical Data

- Case: SMAF
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (e3)
- Polarity: Cathode Band
- Weight: 0.036 grams (Approximate)

SMAF



Top View

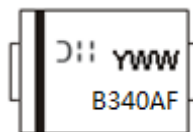
Ordering Information (Note 4)

Part Number	Case	Packaging
B340AF-13	SMAF	10,000/Tape & Reel
B345AF-13	SMAF	10,000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

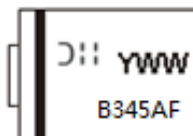
Marking Information

SMAF



B340AF = Product Type Marking Code
 011 = Manufacturers' Code Marking
 YWW = Date Code Marking
 Y = Last Digit of Year (ex: 6 for 2016)
 WW = Week Code (01 to 53)

SMAF



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Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	B340AF	B345AF	Unit
Peak Repetitive Reverse Voltage	V_{RRM}	40	45	V
Working Peak Reverse Voltage	V_{RWM}			
DC Blocking Voltage	V_{RM}			
Average Rectified Output Current	I_O	3		A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I_{FSM}	80		A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	R _{θJA}	35	°C/W
Typical Thermal Resistance Junction to Case (Note 5)	R _{θJC}	6.0	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V _F	—	0.47 0.43	0.50 —	V	I _F = 3A, T _J = +25°C I _F = 3A, T _J = +125°C
Leakage Current (Note 6)	I _R	—	0.03	0.20	mA	V _R = 40V, T _J = +25°C
B340AF		—	15	—		V _R = 40V, T _J = +125°C
B345AF		—	0.04	0.30		V _R = 45V, T _J = +25°C
		—	18.0	—		V _R = 45V, T _J = +125°C
Typical Capacitance	C _T	—	120	—	pF	V _R = 4.0V, f = 1MHz

Notes: 5. Device mounted on 2inch*2inch Al board.
6. Short duration pulse test used to minimize self-heating effect.

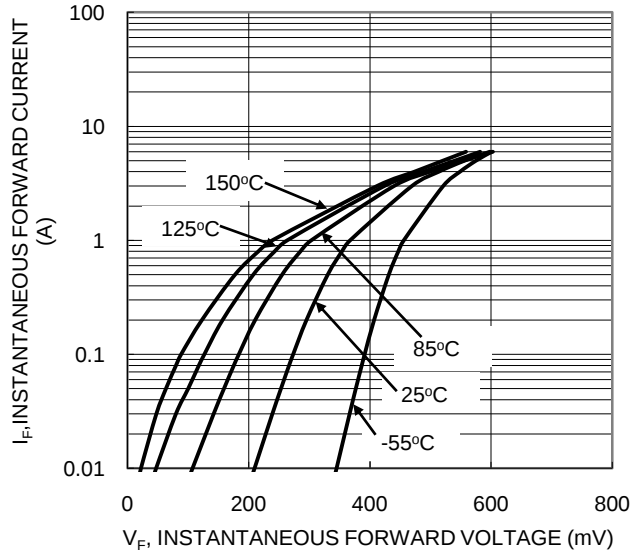


Figure 1. Typical Forward Characteristics

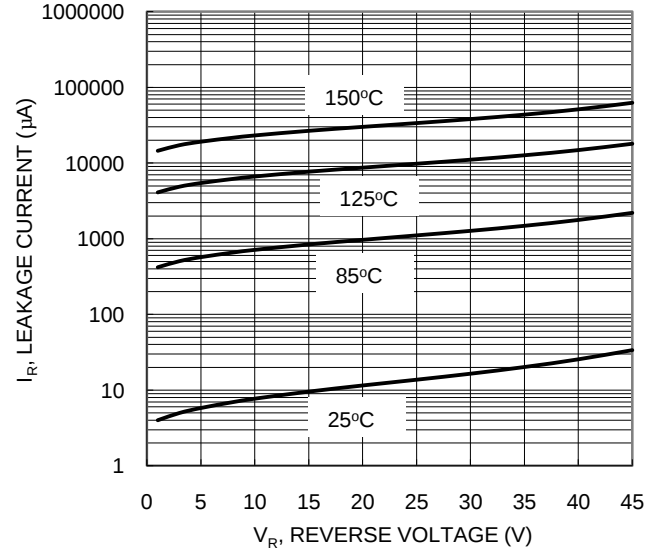


Figure 2. Typical Reverse Characteristics

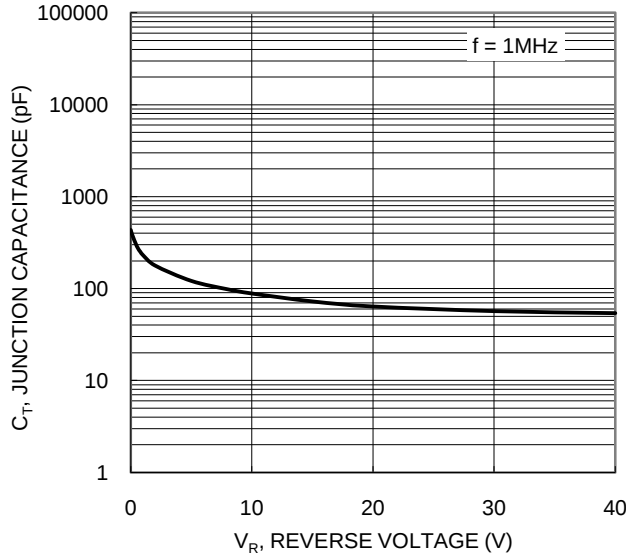


Figure 3. Typical Junction Capacitance

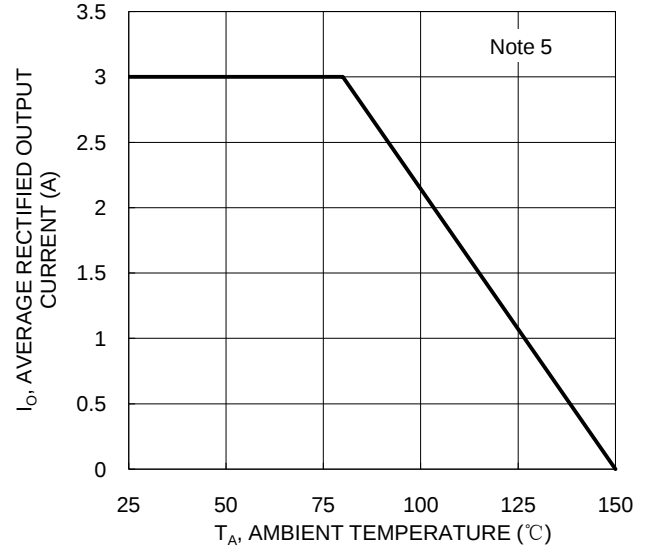


Figure 4. DC Forward Current Derating

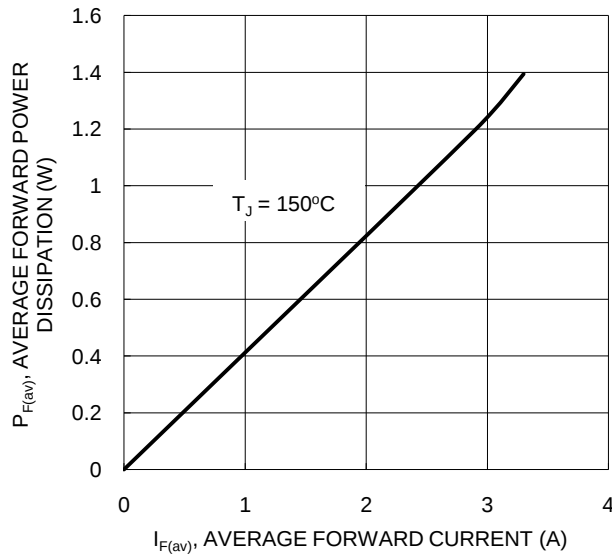
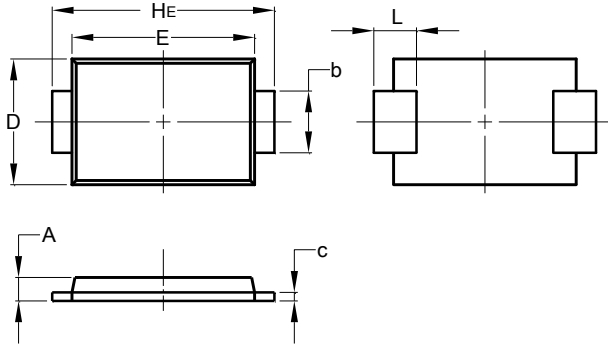


Figure 5. Forward Power Dissipation

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SMAF

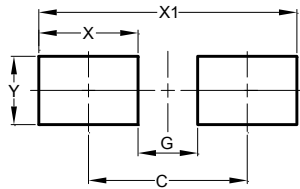


SMAF		
Dim	Min	Max
A	0.90	1.10
b	1.25	1.65
c	0.10	0.40
D	2.25	2.95
E	3.95	4.60
HE	4.80	5.60
L	0.50	1.50
All Dimensions in mm		

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SMAF



Dimensions	Value (in mm)
C	4.00
G	1.50
X	2.50
X1	6.50
Y	1.70

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